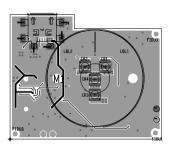
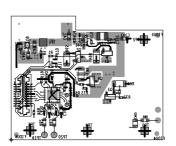
## ART FILM - Layeri



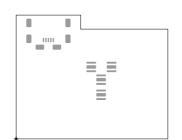
ART FILM - Layer1

## ART FILM - Layer2



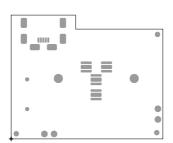
ART FILM - Layer2

ART FILM - paste\_top



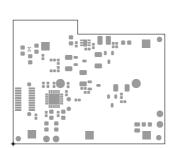
ART FILM - paste\_bottom

ART FILM - soldermask\_top

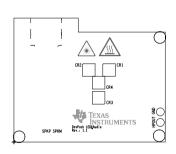


ART FILM - soldermask\_top

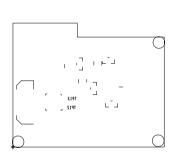
ART FILM - soldermask\_bottom



ART FILM - silk\_top



## ART FILM - silk\_bottom



ART FILM - silk\_bottom

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